# swissbit®

# **EMBEDDED MEMORY AND STORAGE SOLUTIONS**

AUTOMOTIVE COMMUNICATIONS INDUSTRIAL NETWORKING SECURITY



# WHY CHOOSE SWISSBIT

Swissbit, the largest independent embedded memory and storage solutions manufacturer in Europe, was created through a management buyout from Siemens Semiconductor in 2001. With over 20 years of experience in the memory & storage industry Swissbit has become a world class leader in technology, supplying high quality, high reliability memory & storage solutions with all established DRAM and flash interfaces.

Tier 1 customers in the industrial, networking / communication and automotive segments continue to confirm the outstanding product features and quality and rely on Swissbit's excellent technical and logistics support.

# **Corporate Profile**

Established 1992 -2000 as SIEMENS AG

Swissbit AG was formed in 2001 through a management buyout

Financial Strength Privately held company, equity ratio > 60%

Double digit annual growth CAGR 2009-2014 Headquarters Swissbit Group: Zug, Switzerland

Swissbit AG: Bronschhofen (St. Gallen, Lake Constance area)

Subsidiaries Switzerland, Germany, USA, Japan, Taiwan

R & D sites Switzerland, Germany and USA

**Production Site** Berlin, Germany

# Overview of services provided by Swissbit:

# **PRODUCTS**

- Complete line of DRAM modules and NAND Flash Solid State Drives with industry standard interfaces and form factors
- Both leading edge technology and legacy product offerings
- Extended and industrial temperature grade products
- Chip-On-Board (COB) and Systemin-Package technology
- Small form factor removable NAND Flash cards
- Memory in-Package solutions
- Mobile Security Solutions, like Secure microSD, SD and more
- Security firmware, drivers and SDK

# SALES SERVICE AND **ENGINEERING SUPPORT**

- Fast, effective, and competent sales staff on hand to serve your needs
- Our expert technical staff is available for quick response
- Joint product qualification service
- In-house manufacturing in Germany
- Design-in support

# CUSTOMIZATION

- Custom memory and storage solutions
- Security features
- Individual marking
- Conformal coating

# OEM SERVICES

- Controlled bill of materials (BOM)
- Serialization and lot code tracking
- Support of long life cycles
- Stringent PCN and ECN process

# **TEST FOR RELIABILITY**

- Final extended and industrial temperature testing with KTI and Tanisys Technology equipment
- World class Swissbit application testing
- System Level Test During Burn-In (TDBI)
- Environmental testing according to industrial and automotive standards

# **COMPLIANCE TO**

- JEDEC, SDA, CFA, USB-IF, SATA-IO
- RoHS, REACH, and WEEE
- UL
- FCC, CE

# **QUALITY STANDARDS**

- ISO 9001:2008
- TS 16949
- ISO 14001

#### **ASSOCIATIONS**

- JEDEC
- CompactFlash Association (CFA)
- SATA-10
- USB Implementer Forum
- Secure Digital Association (SDA)
- Memory Implementers Forum
- Small Form Factor Special Interest Group SFF-SIG



















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# INDUSTRY

# Typical applications:

# Industrial Automation

- Process- / motion control
- Industrial PC / embedded
- Industrial measurement
- Building technology
- Identification / access systems
- Surveillance

# Energy

- Energy distribution
- Energy consumption
- Smart grid

# Infotainment

- POS terminals
- Information terminals
- Ticket- / vending terminals
- Digital signage and advertising
- Casino gaming
- · VLTs & lottery terminals

### Healthcare

- Diagnostics
- Point of care testing
- Mobil systems
- Imaging

# Transportation

- Train Control and Monitoring Systems (TCMS)
- · Multifunctional terminals
- Data recorders

# Aerospace and defense

- In-flight Entertainment & Communication (IFE&C)
- Communications, Command, Control and Intelligence (C4ISR)
- Combat management systems
- · Battlefield sensor systems









Memory and non-volatile storage solutions for embedded applications must provide reliable operation even in the most extreme conditions (e.g., temperature, shock, and vibration). As such, both the qualification cycle and the support life cycle needed for these products far exceed those of devices designed for typical consumer applications.

Swissbit's embedded memory and storage solutions are the perfect fit for such demanding applications. They offer the highest reliability and quality with long term availability and controlled BOM. To guarantee such high quality standards, each product undergoes thorough functional testing before being released for shipment.

# AUTOMOTIVE

# Typical applications:

- Entertainment systems
- Navigation systems
- Head unit / dashboard
- Black box / crash recorder

The increasing varieties of infotainment and dashboard applications in cars today require significantly higher storage capacities than before. All components used in automotive applications need to operate within a wide temperature range and withstand sudden power loss as well as shock and vibration. Additionally, very low failure rates are essential, because replacements of malfunctioning parts can incur high costs.

Swissbit is the only independent embedded memory and storage manufacturer with TS16949. Our new S-45 SD and microSD memory card lineup caters to the demands of an automotive application, offering the highest reliability and quality at competitive prices.









# Typical applications:

- ATCA Blade
- Cable modem
- Content and video delivery
- Digital Subscriber Line access multiplexer
- · Enterprise Media Gateway
- · Switches and routers

- Optical network
- Radar / Sonar
- Radio network controller
- Security
- · Tetra Base Station
- Wireless Base Station



Telecommunication infrastructure is implemented globally in every possible climate zone; therefore the equipment has to operate under most severe weather conditions such as heat, cold, humidity, or dust. This results in a long, expensive qualification and testing process and the need for products that guarantee long-term availability to minimize the number of requalifications. Our cards provide features that are particularly suitable for NetCom applications, where high reliability, longer duty cycles, and on-field firmware upgrade are key requirements.

Swissbit's product portfolio is very much focused on products and form factors that will dominate the NetCom sector in the near future, such as small form factors like our newest SATA III devices including M.2, mSATA, and slimSATA. Among our solutions, we have customized products able to guarantee a high level of random performance meeting or exceeding most NetCom application requirements.

Swissbit's embedded memory and storage solutions are tested specifically for extreme environmental conditions and guarantee industry leading reliability standards. Long-term relationships with our suppliers allow us to guarantee a fixed BOM along with the highest possible longevity.

# SECURITY

Governments, enterprises, banks, and industry demand high-end security. Swissbit's secure storage solutions offer smart modularization of algorithms and secure storage of encryption keys in one runtime environment. Thus solution providers can concentrate fully on system design while the computation of cryptographic operations is delegated to the trusted execution environment, e.g., a smart card chip in the flash memory device. The Swissbit Security Interface supports all relevant mobile, portable, embedded, and PC platforms.



#### SWISSBIT PRODUCT FEATURES



#### WIDE TEMPERATURE SUPPORT

Swissbit's embedded memory and storage solutions are designed and approved for reliable operation over a wide temperature range. The products are verified at temperature corners and pre-stressed with a burn-in operating functional test (Test During Burn In-TDBI).



#### **ESD AND EMI SAFE**

The product designs are in line with the latest regulations for electrostatic discharge and electromagnetic interference. Swissbit strives to exceed these limits with our own in-house technology and production capabilities, for example with System-in-Package (SiP) competence.



# SHOCK AND VIBRATION

Robustness is one of our key specification targets. The design, assembly, and use of selected materials guarantee an extremely solid design, which has been validated by extensive testing.



# LIFE TIME MONITORING (LTM)

The Swissbit Life Time Monitoring feature enables users to access the memory device's detailed Life Time Status and allows imminent failure prediction thereby avoiding unexpected data loss. This feature uses an extended S.M.A.R.T. (Self-Monitoring, Analysis and Reporting Technology) interface or vendor specific commands to retrieve flash product information.



#### ZONE PROTECTION

The device allows the configuration of multiple zones with either no protection, write protection, or access protected settings. Each zone is secured with a separate password. A Windows tool and a programming library are available.



# SECURE ERASE (SANITIZE/PURGE)/ FAST ERASE

This feature uses an uninterruptable sequence of data erase commands. Even a power-off can't stop the process, which will continue upon restoration of power. The optional enhanced feature allows the customer to sanitize the data according to different standards like DoD, NSA, IREC, etc. The purge algorithm can be started by a software command or through a hardware pin.



#### CONFORMAL COATING

Swissbit offers a special protective coating on selected products. This coating is a thin polyurethane film, which protects against aggressive environmental conditions such as dust, moisture, or corrosive gas.



# TEMPERATURE SENSOR

The sensor allows the host hardware or software to monitor memory device temperature to improve data reliability in the target application environment.



#### **HEAT SPREADER**

Heat spreader for DRAM modules allow temperature hot spots to be dissipated over a larger surface area and improve the module's reliability.



# POWER FAIL PROTECTION AND

# RECOVERY

Intelligent power fail protection and recovery protects data from unexpected power loss. During an unintentional shutdown, firmware routines and an intelligent hardware architecture ensure that no corruption of user or system data will occur.



# **WEAR LEVELING**

Sophisticated wear leveling and bad block management ensure that flash cells are sparingly and equally used to prolong the device's life.



# READ-ONLY OPTIMIZED

In many industrial applications, content is written to the NAND flash once and is only read afterwards. For such cases, the firmware can be optimized to guarantee the highest possible data retention and less read disturb.



# TRIM SUPPORT

The TRIM command allows the operating system to inform the SSD about which blocks of data are no longer considered in use and can be wiped internally, which increases system performance during subsequent write accesses. With TRIM support, data scrap, which would otherwise slow down future write operations to the involved blocks, can be deleted in advance.



# LOW POWER CONSUMPTION

Electronic devices with lower power consumption increase the value of the product, because they decrease energy cost, prolong battery life, and reduce heat generation in the device and hence require less cooling.



#### **DATA CARE MANAGEMENT**

Various effects like data retention, read disturb limits, or temperature can impact data reliability. The latest generation of Swissbit products uses special methods to maintain and refresh the data for greater data integrity.



### **HIGH PERFORMANCE**

Optimized for high sequential data rate and IOPS by use of SLC technology.



# IN FIELD FW UPDATE

The storage product can be upgraded with new FW in the field. The upgrade process is protected against power loss.



#### LONGEVITY

The longevity product lines use special components with a long-term supply commitment of up to ten years. These products offer the lowest TCO in demanding applications with high regualification cost.



#### **WAF REDUCTION**

The WAF (write amplification factor) for MLC based products is reduced by combining a paged based FW block management with a powerful card architecture and configuration settings.

#### **SECURITY FEATURES**



#### TRUE HARDWARE RNG

True random numbers are generated inside the secure element. True randomness is the key prerequisite for secure systems to prevent brute force attacks.



# DIGITAL SIGNATURE AND

# VERFICATION

Digital signatures are very popular and inevitable to protect against data or code manipulation.



### HARDWARE BASED DATA

#### **ENCRYPTION**

Hardware based security is key when it comes to replaceability, simple workflows, and trusted runtime environments.



# MOBILE BANKING AND EPURSE

Swissbit Security products for mobile banking and payment offer strong authentication and offline security.



# DEVICE PROTECTION BY DUAL FACTOR AUTHENTICATION

The user needs to have the card and know the PIN.



#### SECURE VOICE

Secure Voice calls are a requirement for confidential communication. Swissbit Security products are optimal for fast, encrypted, user friendly secure voice solutions.



# **ELLIPTIC CURVE CRYPTOGRAPHY**

# SUPPORT

Elliptic curves are faster and more efficient than RSA cryptography.



### SECURE CD-ROM

The flash memory can be partially or totally switched to read-only. This function ensures that e.g., important data can be modified only after PIN authentication.



# DATA PROTECTION AND ENCRYPTION

Various data protection modes ensure privacy of stored data. The card offers a data safe function with strong AES encryption and PIN access protection.



#### SECURE LOGGING

In large, hidden storage, any system event log, tax data, consumption data, or audit trails can be stored securely in write-once mode, queue mode, or random access mode.



#### PRE-SALES

YOUR FUTURE WITH OUR SOLUTION

Swissbit's experienced BDM and FAE teams in Europe, North America, and Asia support you in the selection and qualification of the most suitable memory and storage solution for your applications.

#### Our services include

- TCO support,
- consulting (design / concept / technology),
- qualification cycle support & joint qualification,
- evaluation units,

- hardware customization,
- firmware customization,
- · midware customization for security products, and
- consulting for your future product generations.



#### AFTERSALES

LOCAL SUPPORT — GLOBALLY

Our engagement stretches far beyond the delivery of our products. Through sophisticated lifecycle management, we can ensure maximum longevity and smooth transitions in the event of product changes. And while we are proud of our best-in-class quality, we are still prepared to provide fast and solution-oriented RMA support at any time, including 4D and 8D reports whenever required.

# Our services include

- · local high level engineering support,
- · longevity of product lines up to ten years,
- field support (including firmware upgrades),
- full product and service life support, and
- PCN process.

# SALES

LOCAL SUPPORT — GLOBALLY

We understand the importance of providing local support in your language and time zone. For that reason, Swissbit has established sales offices in all major regions plus a strong network of partners that reaches even farther. Our experienced sales teams manage forecasting and order fulfillment, if desired also through third-party logistics or distribution networks.

# Our services include

- Global Account and Key Account Management,
- highly sophisticated channel partners who can support sampling within 24 hours,
- · fast, reliable response time,
- highly reliable inventory management using an integrated CRM/ERP/BI system for smart data analysis and forecasting.

#### SWISSBIT'S EMBEDDED STORAGE SOLUTIONS

OEM's of various industries require a variety of memory and storage solutions. In contrast to typical consumer devices, Swissbit's embedded memory and storage solutions are designed for highest reliability under extreme environmental conditions. They come with a large feature set tailored to the demands of the industrial, automotive, and NetCom markets and with our commitment to long-term availability. Swissbit's embedded memory and storage solutions portfolio covers all relevant interfaces and form factors including SD and microSD memory cards, CompactFlash™ and CFast™ cards, 2.5" PATA and SATA SSDs, SLIM SATA and mSATA SSDs, M.2, USB Flash Drives (UFD) and modules. Our sophisticated flash handling algorithms optimize performance and life of the Single Level Cell (SLC) and Multi Level Cell (MLC) NAND flash used in our products.

Swissbit has created a new product family named durabit that features highest endurance and unprecedented random write performance by using a page based FW translation layer in combination with architectural and configuration improvements.

Product development according to stringent design rules and extensive product qualification procedures ensures the electrical and mechanical robustness of Swissbit's embedded storage solutions. All products are offered in commercial (o°C to +70°C) and industrial (-40°C to +85°C) temperature ranges. Available flash handling features include diagnostic information, built-in error correction. bad block management, static and dynamic wear leveling and power fail protection. Our service team can offer product life time calculations for special use cases with specific workloads. The diagnostic features we provide enable our customers to access device state information and schedule replacements before the system stops working.

	SLC	EM-MLC	durabit The better MLC	MLC	TLC
Chip Capacity	++	+++	+++	+++	++++
Cost per Bit	++++	+++	++	++	+
Reliability & Endurance	++++	+++	+++	++	+
Industrial Temperature	++++	+++	+++	+++	+
Write Performance	++++	++	++++	+++	+
ECC Requirement	+	++	++	++	++++
Data Retention	++++	++	+++	+++	+
Longevity	++++	+++	++	++	+

NAND FLASH TECHNOLOGY COMPARISON

++++ highest; +++ high; ++ medium; + low





Swissbit offers various 2.5" SSDs with SATA II and III interfaces. The new X-60 SATA III drives target industrial and NetCom applications with features such as ATA-8, NCO and TRIM and enable highest sequential performance and excellent IOPS rate. The X-60 SSDs use latest generation MLC flash technology with a powerful controller architecture which provides best price /performance ratio.

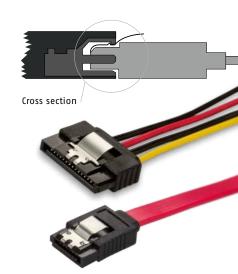
Swissbit's X-500 and X-55 SATA II SSDs are designed as a rugged and extremely reliable storage solution for reliable operation in harsh environmental conditions such as wide temperature range, shock, vibration, or humidity. They use the most reliable SLC (X-500) or EM-MLC (X-55) NAND flash available on the market today and comprise a large number of features.

All drives feature various options for Secure Erase, Purge, and Sanitize methods as well as support for a detailed, S.M.A.R.T. based Life Time Monitoring tool that allows the user to have full control of mission critical data at any given time. The BCH-ECC (error correction code) in combination with an intelligent power fail protection mechanism guarantees the highest possible data reliability.

X-500 SSDs are the ideal solution for applications requiring the highest level of endurance or maximum longevity. The X-55 series were designed for industrial applications with a balanced read / write workload and offer more than ten times the endurance of SSDs using standard MLC.

# LOCKING / LATCHING SATA CONNECTOR

Swissbit's X-500 and X-55 SSDs are designed with a latching SATA connector. Multiple notches support the latching cables for highest vibration and shock



	<b>%</b>	7		TOTAL PROPERTY OF THE PROPERTY		5.		<b>₩</b>	55			<b>3</b>	$\infty$	<b>WAF</b>
X-60	•	•	•	•	•	•	•	*	•	•	•	*	0	•
X-55	•	•	•	•	•	•	•	*	•	•	•	0	0	0
X-500	•	•	•	•	•	•	•	*	•	•	•	0	•	0
X-200	•	•	•	•	0	•	0	*	•	•	0	0	•	0

★ Industry Leading; default implemented; on request; not available







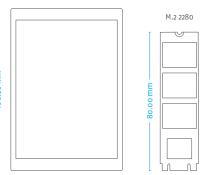


	2.5" SATA III	2.5" SATA	2.5" SATA	2.5" SATA
	SSD	SSD	SSD	SSD
Series Name	X-60	X-55	X-500	X-200
Interface Data Transfer Mode	SATA III - 6 Gbit/s ATA8		SATA II – 3 Gbit/s up to UDMA6 / PIO4 / MDMA2	
Connector	15+7 pin serial ATA		with latch protection <i>l</i> ure connector	15 + 7 pin Serial ATA
Outline Dimensions	100.2 x 69.85 x 7.0 mm		100.2 x 69.85 x 9.3 mm	
Flash Type	MLC	EM-MLC	S	LC
Density Range	30 GB - 960 GB	30 GB - 480 GB	16 GB - 512 GB	4 GB - 8 GB
Data Retention	10 years @ life begin 1 year @ life end	5 years @ life begin 3 months @ life end		) life begin ) life end
Endurance	1820 TBW (1 TB, Enterprise workload)	420 / 310 TBW (60 GB, JESD219 Client / Enterprise workload)	2700 / 370 TBW (64 GB, JESD219 Client / Enterprise workload)	100,000 P/E cycles (Flash cell level)
Operating Temperature			l: o°C to +70°C -40°C to +85°C	
Storage Temperature	-40°C to +85°C	-55°€ t	o +95°C	-50°C to +100°C
Performance  Burst Rate (MB/s)  Sequential Read (MB/s)  Sequential Write (MB/s)  Random 4KB Read (IOPS)  Random 4KB Write (IOPS)	up to 520 up to 450 up to 75,000	up to 300 up to 240 up to 160 up to 14,800 up to 3,200	up to 300 up to 240 up to 220 up to 14,500	up to 300 up to 120 up to 95 up to 3,100
MTBF	up to 75,000		up to 5,300	up to 25
		≥ 2,000,000 hours		≥ 2,500,000 hours
Shock		-STD810; 2,000 G, 0.4 ms; 50 G,		1,500 G
Vibration	MI	L-STD810; 20 G, 10-2,000 Hz rand	dom	20 G
Humidity		85 % RH 85	°C, 1,000 hrs	
Voltage	5 V ± 10% / 3.3 V ± 5%		10 % ptional	5 V ± 10 %
Power Consumption	typ 300 mA max 1200mA Idle 60 mA DEVSLP 25 mA	Slumbe max Idle	max 320 mA Idle 140 mA	
Features & Tools	Proven Power Fail Safety NCQ, TRIM Advanced Wear Leveling & Bad Block management In-field firmware update SBLTM Tool & SDK for S.M.A.R.T. based Life Time Monitoring	Proven Pow ATA security Enhanced Secure Erase, Purge NCQ, Advanced Wear Leveling In-field firm SBLTM Tool & SDK for S.M.A.R.	Proven Power Fail Safety Security Features available Wear Leveling & Bad Block management SBLTM Tool & SDK for S.M.A.R.T. based Life Time Monitoring	
Part Number	SFSAxxxxQvAAxss-t-dd-rrr-ccc	SFSAxxxxQvBJx	ss-t-dd-rrr-ccc	SFSAxxxxQvBRxss-t-dd-rrr-ccc
		,		



SOLID STATE DRIVE

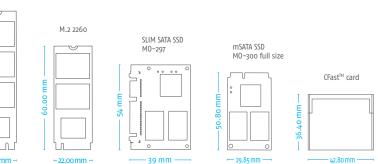
SATA 2.5"



Swissbit's mSATA (M0-300), SLIM SATA (M0-297) and the M.2 SSDs are ideal solutions for embedded applications requiring solid state storage in smaller, removable form factors. Our SATA SSD modules offer a long service life combined with controlled BOM and a change notification process. Each unit undergoes extensive testing over the full temperature range before being released for shipment.

The X-60 SATA III series is Swissbit's solution for high performance, cost sensitive, high capacity markets. The SSD modules are available as mSATA (X-60m), SLIM SATA (X-60s), and M.2 (X-60m2). They were designed for all industrial, NetCom, and automotive applications requiring high data transfer rates up to 520 MB/s in sequential access and 75,000 IOPS in 4 KB random access. In addition, they offer a wide range of features such as Swissbit's proven Power Fail Safety, ATA security feature set, Data Care Management tools, a Windows or Linux tool and SDK for detailed S.M.A.R.T.-based Life Time Monitoring, NCQ, TRIM, advanced wear leveling and bad block management and in-field firmware update functionality.

The newly introduced SLC-based X-600 series are highly reliable storage solutions with outstanding endurance and are available with the same set of features as the X-60 products. They are built using the most reliable SLC flash on the market and an industrial grade SATA III controller and operate from -40°C to 85°C.



PRODUCT SIZE COMPARISION

	*	7				1							$\infty$	- WAF
X-600s / m / m2	•	•	•	•	•	•	•	*	•	•	*	*	0	0
X-60s / m / m2	•	•	•	•	•	0	•	*	•	•	*	*	0	•
X-200m	•	•	•	0	0	•	0	•	•	0	0	0	•	0
X-200s	•	•	•	0	0	•	0	•	•	0	0	0	•	0

<sup>★</sup> Industry Leading; default implemented; on request; not available

# SLC BASED MODULES













	MO-300	MO-297	M.2	М.2	MO-300	MO-297
	FULL SIZE	SLIM SATA	2242	2260/	FULL SIZE	SLIM SATA
				2280		
Series Name	X-600m	X-600s	X-60	00m2	X-200m	X-200s
Interface Data Transfer Mode		SATA III – 6 Gbit/s ATA8	S			· 3 Gbit/s IDMA2, UDMA6
Connector	52 pos. Edge Connector PCI Express (PCIe) mini	15 + 7 pin Serial ATA Connector		e Connector M key	52 pos. PCI Express (PCIe) mini	15 + 7 pin Serial ATA Connector
Outline Dimensions	50.8 x 29.85 mm	54 x 39 mm	22 X 42 mm	22 x 60 / 80 mm	50.8 x 29.85 mm	54 x 39 mm
Thickness	3.3 mm	4.0 mm	3.6 mm	DS: 3.6 mm SS: 2.0 mm	3.3 mm	4.0 mm
Flash Type			S	LC		
Density Range	8 GB - 128 GB	16 GB - 128 GB	8 GB - 64 GB	16 GB - 128 GB	2 GB -	64 GB
Data Retention				) life begin ) life end		
Endurance	n	nax. 7.58 TBW per GB driv (JEDEC Enterprise V				P/E cycles ell level)
Operating Temperature				o°C to +70°C 40°C to +85°C		
Storage Temperature			-40°C t	o +85°C		
Performance Burst Rate (MB/s) Sequential Read (MB/s) Sequential Write (MB/s) Random 4KB Read (10PS) Random 4KB Write (10PS)	up to up to	0 600 0 520 0 405 76,000 73,000	up to 600 up to 520 up to 245 up to 76,000 up to 54,000	up to 600 up to 520 up to 405 up to 76,000 up to 73,000	up t up t up to	0 300 0 120 0 95 3,100 to 25
Voltage	3.3 V ± 5 %	5 V ± 10 %	3.3 V	± 5 %	3.3 V ± 5 %	5 V ± 10 %
Power Consumption	typ 450 mA max 750 mA Idle 115 mA DEVSLP 35 mA	typ 300 mA max 575 mA Idle 110 mA DEVSLP 55 mA	typ 400 mA max 515 mA Idle 105 mA DEVSLP 35 mA	max 750 mA Idle 115 mA	typ 300 mA max 490 mA Idle 180 mA	typ 260 mA max 320 mA Idle 140 mA
Features & Tools		Proven Power Fail Sa NCQ, TRIM d Wear Leveling & Bad Bl In-field firmware up & SDK for S.M.A.R.T. based		Proven Power Fail Safety Advanced Wear Leveling & Bad Block management SBLTM Tool & SDK for S.M.A.R.T. based Life Time Monitoring		
Part Number	SFSAxxxxUvAAxss-t- dd-rrr-ccc	SFSAxxxxVvAAxss-t- dd-rrr-ccc	SFSAxxxxM- vAAxss-t-dd- rrr-ccc	SFSAxxxxM- vAAxss-t-dd- rrr-ccc	SFSAxxxxUvBRxss-t- dd-rrr-ccc	SFSAxxxxVvBRxss-t- dd-rrr-ccc





**FLASH LIFE TIME PREDICTION** 

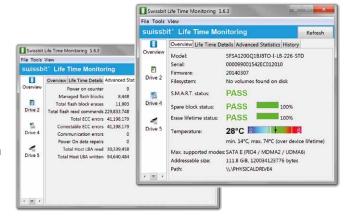
The endurance of flash based products is primarily defined by the maximum number of program / erase cycles of the flash components. SLC components normally allow 100,000 PE cycles per block while MLC is typically specified as 3,000 PE cycles.

This transparency of NAND component endurance is no longer provided for integrated flash cards with controllers and firmware. For each write that the host initiates, the flash controller has to perform internal management steps and may need to erase and write multiple blocks even at the smallest external write transfer size.

The ratio between internal write data volume and the external request size is called WAF (write amplification factor) and can vary between one (theoretical best case) and several hundred depending on card structure, flash components used, firmware architecture, and userapplication write profile.

The WAF directly influences the IOPS rate but the endurance even more. With a WAF of 100, internal PE cycles are 100 times higher than expected from the external data rate, and the endurance limit is reached 100 times faster than anticipated.

Customer application use cases have a huge impact on the WAF. In most cases, how the software's access profile will translate into flash writes can hardly be predicted.

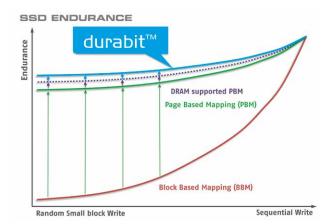


Swissbit supports a realistic forecast of the WAF and the endurance of their SSDs and storage cards with help of the Swissbit Life Time Monitoring Tool and statistical data stored into the flash by the firmware. This tool can read out the real usage data such as number of writes, number of erase cycles, the bad block statistic, the successful ECC correction, and provides all the data necessary to extrapolate the life time of the device.

### **ENDURANCE OPTIMIZATION**

The WAF can be significantly reduced from several hundreds to single digit values by using a page based firmware translation layer (FTL). Especially for MLC flash this means a significant improvement in endurance.

The Swissbit durabit products use MLC flash and page based FTL and offer unprecedented endurance. durabit SSDs even increase this benefit by a DRAM supported FTL and increased overprovisioning which enables the highest available endurance with MLC technology.



# MLC BASED MODULES









	MO-300	MO-297	м.2	M.2					
	FULL SIZE	SLIM SATA	2242	2260/ 2280					
Series Name	X-60m	X-60s	Х-6	0m2					
Interface Data Transfer Mode			- 6 Gbit/s A8						
Connector	52 pos. Edge Connector PCI Express (PCIe) mini	15 + 7 pin Serial ATA Connector	75 pos. Edge Cor	nnector B & M key					
Outline Dimensions	50.8 x 29.85 mm	54 x 39 mm	22 X 42 mm	22 x 60 / 80 mm					
Thickness	3.3 mm	4.0 mm	3.6 mm	DS: 3.6 mm SS: 2.0 mm					
Flash Type		MLC d	urabit						
Density Range	8 GB - 480 GB	30 GB - 480 GB	30 GB - 240 GB	30 GB - 480 GB					
Data Retention			) life begin ) life end						
Endurance		max. 1.9 TBW per GB drive capacity (per JESD219)							
Operating Temperature			: o°C to +70°C -40°C to +85°C						
Storage Temperature		-40°C t	o +85°C						
Performance Burst Rate (MB/s) Sequential Read (MB/s) Sequential Write (MB/s) Random 4KB Read (IOPS) Random 4KB Write (IOPS)	up t up to up to	0 600 0 520 0 450 75,000 75,000	up to 600 up to 520 up to 340 up to 72,000 up to 78,000	up to 600 up to 520 up to 450 up to 75,000 up to 75,000					
Voltage	3.3 V ± 5 %	5 V ± 10 %	3.3 V ± 5 %						
Power Consumption	typ 500 mA max 960 mA Idle 115 mA DEVSLP 35 mA	typ 450 mA max 750 mA Idle 110 mA DEVSLP 55 mA	typ 400 mA max 495 mA Idle 110 mA DEVSLP 35 mA	typ 500 mA max 960 mA Idle 115 mA DEVSLP 35 mA					
Features & Tools	Proven Power Fail Safety NCQ, TRIM Advanced Wear Leveling & Bad Block management In-field firmware update SBLTM Tool & SDK for S.M.A.R.T. based Life Time Monitoring								
Part Number	SFSAxxxxUvAAxss-t-dd-rrr-ccc	SFSAxxxxVvAAxss-t-dd-rrr-ccc	SFSAxxxxMvAAx	xss-t-dd-rrr-ccc					





CFast™ CARDS

CFast™ cards combine two existing industry standards into a single product: the CompactFlash™ (CF) card form factor and the Serial ATA (SATA) interface commonly used in hard disks. CFast™ cards can replace both HDDs and CompactFlash™ cards in applications requiring small form factors, high endurance and the ability to withstand shock, vibration, extreme temperatures (-40°C to +85°C), high altitude and rough environmental conditions. Swissbit's CFast™ cards provide rugged storage for embedded and industrial systems where performance, data and system reliability, power fail protection and flexibility are important design considerations.

Swissbit CFast™ cards operate with a 3.3 Volt low power source and support three SATA power management states: Active, Partial, and Slumber. This standard is a perfect choice for both boot devices and as removable media for applications requiring low to medium storage densities with a small footprint. Additionally, the Swissbit CFast™ cards come with full engineering and customization support, S.M.A.R.T. based Life Time Monitoring features, our intelligent flash Management algorithms and Error Correction, guaranteeing the highest level of reliability even in rough application environments.

Swissbit's latest innovations are the F-60 / F-600 SATA III CFast™ card series. Using state of the art controllers and MLC / SLC flash technology, the F-60 / F-600 achieve data transfer rates up to 520 MB/s in sequential access and 76,000 IOPS in 4 KB random access. In addition, the F-60 / F-600 series feature Swissbit's proven Power Fail Safety, ATA security feature set, enhanced Secure Erase tools, a Windows or Linux tool and SDK for detailed S.M.A.R.T.-based Life Time Monitoring, NCQ, TRIM, advanced wear leveling and bad block management or in-field firmware update functionality.

	<b>*</b>	7		TOT TOT		-		<b>₩</b>					$\infty$	WAF
F-600	•	•	•	*	•	•	•	*	•	•	•	*	0	0
F-60	•	•	•	*	•	•	•	*	•	•	•	*	0	•
F-50	•	•	•	*	•	•	•	*	•	•	•	*	0	0
F-240	•	•	•	*	0	•	0	*	•	*	•	0	•	0

★ Industry Leading; default implemented; on request; not available









	CFAST <sup>TM</sup> CARD	CFAST <sup>TM</sup> CARD	CFAST <sup>TM</sup> CARD	CFAST <sup>TM</sup> CARD		
Series Name	F-600	F-60	F-50	F-240		
Interface Data Transfer Mode		CFast™ 2.0 - SATA III - 6 Gbit/s ATA8		CFast™ 1.0 – SATA II – 3 Gbit/s ATA7		
Connector		CFast™	¹ Type I			
Outline Dimensions		36.4 x 42.8	8 x 3.6 mm			
Flash Type	SLC	MLC durabit	MLC	SLC		
Density Range	8 GB - 64 GB	8 GB - 240 GB	8 GB - 256 GB	2 GB - 64 GB		
Data Retention			D life begin D life end			
Endurance	7.6 TBW per GB drive capacity	0.3 TBW per GB drive capacity	0.2 TBW per GB drive capacity	100,000 P/E cycles (Flash cell level)		
Operating Temperature			: o°C to +70°C 4o°C to +85°C			
Storage Temperature		-40°C t	o +85°C			
Performance Burst Rate (MB/s) Sequential Read (MB/s) Sequential Write (MB/s) Random 4KB Read (IOPS) Random 4KB Write (IOPS)	up to 520 up to 245 up to 76,000	up to 600 up to 520 up to 180 up to 72,000 up to 43,000	up to 600 up to 465 up to 325 up to 7,000 up to 37,000	up to 300 up to 120 up to 120 up to 3,200 up to 75		
MTBF	up to 54,000	≥ 2,000,000 hours	up to 311000	≥ 2,500,000 hours		
Shock	MII-	-STD810; 2,000 G, 0.4 ms; 50 G, 1	ıı mç	1,500 G		
Vibration		STD810; 20 G, 10-2,000 Hz rand		20 G		
Humidity			°C, 1,000 hrs	200		
Voltage			± 5 %			
Power Consumption	typ 450 mA max 715 mA Idle 105 mA DEVSLP 35 mA	typ 400 mA max 495 mA Idle 110 mA DEVSLP 35 mA	typ 290 mA max 420 mA Idle 75 mA DEVSLP 35 mA	typ 140 mA max 250 mA Idle 55 mA PHYSLP <20 mA		
Features & Tools	Proven Power Fail Safety Sophisticated Wear Leveling & Bad Block management Read Disturb Management TRIM Low Power Consumption Security & SBZoneProtection features available SBLTM Tool & SDK for S.M.A.R.T. based Life Time Monitoring  Evaluation kit with 2.5" SATA adapter board available					
Part Number		SFCAxxxxHvAAxss-t-dd-rrr-ccc		SFCAxxxxHvBVxss-t-dd-rrr-ccc		



### CompactFlash™ CARDS



To this day, CompactFlash™ (CF) cards remain the most popular flash-based storage solution used in the embedded and industrial markets and the CompactFlash™ card form factor and connector are well established. Swissbit's CF cards were developed with strong focus on quality, reliability, robustness, and longevity. We select only high-quality components and apply design rules fitting the stringent requirements of our customers. Hardware and firmware were tested and qualified by our experienced technical team and features and functionality have been proven in many challenging customer applications. Swissbit's CF Series C-3xo and C-4xo are offered in both commercial (o°C to +70°C) and industrial (-40°C to +85°C) temperature ranges, providing rugged, reliable memory for a wide range of demanding use cases. They are designed to address a broad range of concerns from compatibility, booting, and power fail safety to long-term supply, controlled BOM, and outstanding flash protocolhandling techniques to ensure highest possible data integrity. In contrast to commonly promoted sequential performance values, Swissbit is especially focused on optimized random-access speed, one of the key requirements in legacy embedded CompactFlash applications.

Swissbit's most recent CF card product family is the C-300 Longevity series, which offers maximum long-term availability (until at least 2021). In addition, the C-300 Longevity CF card ensures optimized backward compatibility with legacy systems, high random access speed, and a wide range of capacities from 32 MB to 8 GB using highly reliable SLC flash with 100,000 program / erase cycles.

		7	<b>7</b>			11		<b>5</b>			$\infty$
C-300	•	•	•	•	0	•	*	•	0	0	•
C-300 LONGEVITY	•	•	•	*	0	•	*	•	•	0	*
C-320	•	•	•	•	•	•	*	•	•	0	•
C-440	•	•	•	*	•	•	*	•	*	•	•

<sup>★</sup> Industry Leading; 
■ default implemented; 
■ on request; 
○ not available

# swissbit®









	COMPACTFLASH™	COMPACTFLASH™	COMPACTFLASH™	COMPACTFLASH™			
	CARD	CARD	CARD	CARD			
Series Name	C-300	C-300 Longevity	C-320	C-440			
Interface Data Transfer Mode	True ID	CFA4.1 E / PC card – Up to UDMA4, MDMA4 8	CFA5.0 True IDE / PC card - Up UDMA6, MDMA4 & PIC				
Connector		СЕС Тур	oe I				
Outline Dimensions		36.4 x 42.8 >	c 3.3 mm				
Flash Type		SLC					
Density Range	128 MB - 8 GB	32 MB - 8 GB	2 GB - 32 GB	2 GB - 64 GB			
Data Retention		10 years @ li 1 year @ li					
Endurance		100,000 P/I (Flash Cell	•				
Operating Temperature		Commercial: o°C Industrial: -4o°C					
Storage Temperature		-50°C to +	+100°C				
Performance Burst Rate (MB/s) Sequential Read (MB/s) Sequential Write (MB/s) Random 4KB Read (IOPS) Random 4KB Write (IOPS)	up to 37 up to 20 up to 3,300	up to 66 up to 37 up to 20 up to 3,300 up to 50	up to 66 up to 45 up to 35 up to 2,800 up to 44	up to 133 up to 65 up to 40 up to 2,400 up to 300 (with TRIM)			
MTBF	-F 1	≥ 3,000,00	1	ap 22 322 ()			
Shock		1,500					
Vibration		20 G					
Humidity		85 % RH 85°C	, 1,000 hrs				
Voltage		3.3 V ± 5 V ± 10					
Power Consumption		50 mA @ 3.3 V 70 mA @ 3.3 V 110 mA @ 5 V	PIO typ 60 mA @ 3.3 V DMA typ 90 mA @ 3.3 V DMA typ 130 mA @ 5 V	PIO typ 60 mA @ 3.3 V DMA typ 80 mA @ 3.3 V DMA typ 90 mA @ 5 V			
Features & Tools	Sophisticated Wear Levelin Security & SBZoneProte	rer Fail Safety g & Bad Block management ection features available .T. based Life Time Monitoring	Proven Power Fail Safety Sophisticated Wear Leveling & Bad Block management Read Disturb Management TRIM Security & SBZoneProtection features available SBLTM Tool & SDK for S.M.A.R.T. based Life Time Monitoring				
Part Number	SFCFxxxxHxBKxss-t-xx-rrr-ccc	SFCFxxxxHxBKxss-t-xx-rrr-ccc	SFCFxxxxHxB0xss-t-dd-rrr-ccc	SFCFxxxxHvBUxss-t-dd-rrr-ccc			





# **FLASH MANAGEMENT** MECHANISM

- Optimized error correction code
- Efficient algorithms for bad block management
- Real life time monitoring
- Sophisticated wear leveling and bad block management
- Power fail protection

microSD MEMORY CARDS

Swissbit's Industrial microSD Memory Cards are designed, manufactured and tested to withstand extreme environmental conditions. Each of our product series is designed for a broad, embedded use case with its unique requirements for longevity, service life, endurance, temperature, data retention, and cost.

The new durabit S-45u series combines latest MLC technology with an innovative controller and a sub-page based firmware that enables unprecedented random write performance and an up to 100 times higher endurance compared to standard microSD card solutions. The special firmware features in the S-45u include powerful built-in error correction, read retry, autonomous data care management, randomizer, wear leveling and bad block management algorithms, and intelligent power fail protection. The Swissbit microSD memory cards are supported by the Swissbit life time monitoring for real time status information. Applications that demand highest endurance and performance benefit from the equally featured but SLC flash technology based S-450u. This series supports data transfer rates of up to 80 MB/s. Both S-450u and S-45u fulfill UHS-I, class 10 speed grade.

All Swissbit microSD Cards can withstand extreme environmental conditions. They provide the highest level of mechanical stability and enhanced ESD protection. Furthermore, the hard gold SD connectors endure a minimum of 20,000 insertion cycles.

	<b>*</b>	4		8	**	₩ <u></u>	<u> </u>		8	$\infty$	WAF
S-300u	•	•	•	0	•	•	•	•	0	•	0
S-200u	•	•	•	•	•	*	•	0	0	•	0
S-45u	•	•	•	*	•	*	•	*	*	0	*
S-450u	•	•	•	*	•	*	•	*	*	•	0

★ Industry Leading; • default implemented; • not available









	microSD	microSD	microSD	microSD			
	MEMORY	MEMORY	MEMORY	MEMORY			
	CARD	CARD	CARD	CARD			
	(SD / SDHC)	(SD)	(SD / SDHC)	(SDHC)			
Series Name	S-300u	S-200u	S-450u	S-45u			
Interface Data Transfer Mode	SD 2.0, Class 6 / 10	SD 2.0, Class 6	SD 3.0, Cla	ss 10, UHS-I			
Connector		mic	roSD				
Outline Dimensions		15 X 11 X (	0.7 / 1 mm				
Flash Type		SLC		MLC durabit			
Density Range	1 GB - 2 GB (SD) 4 GB - 8 GB (SDHC)	512 MB - 2 GB (SD)	512 MB - 2 GB (SD) 4 GB - 8 GB (SDHC)	4 GB - 32 GB (SDHC) 64 GB (SDXC)			
Data Retention			) life begin ) life end				
Endurance		100,000 P/E Cycles (Flash Cell Level)		3,000 P/E Cycles (Flash Cell Level)			
Operating Temperature	Extended: -25°C to +85°C Industrial: -40°C to +85°C						
Storage Temperature	-40°C to +85°C						
Performance Burst Rate (MB/s) Sequential Read (MB/s) Sequential Write (MB/s) Random 4KB Read (10PS) Random 4KB Write (10PS)	up to 24	up to 25 up to 21 up to 18	up to 104 up to 80 up to 75 up to 1200 up to 30	up to 50 up to 40 up to 12 up to 750 <b>up to 650</b>			
MTBF		≥ 3,000,0					
Shock		1,50	1,500 G				
Vibration		50	o G				
Humidity	93 % RH 40°C, 500 hrs		85 % RH 85°C, 1,000 hrs				
Voltage		2.7 -	3.6 V				
Power Consumption	Read typ 50 mA Write typ 50 mA	Read typ 30 mA Write typ 40 mA	Read typ Write typ				
Features & Tools	Proven Power Fail Safety Advanced Wear Leveling & Bad Block management	Proven Power Fail Safety Sophisticated Wear Leveling & Bad Block Management Diagnostic features Life Time Monitoring	Sophisticated Wear mana <sub>t</sub> Autonomous Data	er Fail Safety Leveling & Bad Block gement Care Management ailed Life Time Monitoring			
Part Number	SFSDxxxxNxBWxss-t-dd- rrr-ccc	SFSDxxxxNxBNxss-t-dd- rrr-ccc	SFSDxxxxNxBMx	kss-t-dd-rrr-ccc			





**SD MEMORY CARDS** 

Secure Digital (SD) memory cards have a wide spread use in industrial and automotive application, ranging from read only applications as in navigation systems to utilization as boot media, for video recording or data logging. Swissbit's Industrial Secure Digital (SD) card series are designed for high sustained performance and endurance over the entire lifetime and are manufactured and tested to withstand extreme environmental conditions. They provide the highest level of mechanical stability and enhanced ESD protection.

Each of our product series meets the stringent industry requirements for longevity, service life, endurance, temperature, data retention, and overall cost.

The new durabit S-45 series combines latest MLC technology with an innovative controller and a sub-page based firmware that enables unprecedented random write performance and an up to 100 times higher endurance compared to standard SD card solutions. The S-45 firmware features include powerful built-in error correction, read retry, autonomous data care management, randomizer, wear leveling and bad block management algorithms, and intelligent power fail protection. The Swissbit SD memory cards are supported by the Swissbit life time monitoring for real time status information.

Applications that demand highest endurance and performance benefit from the SLC based S-450. This series supports data transfer rates of up to 80 MB/s and offers the same data care features as the S-45. Both S-450 and S-45 fulfill UHS-I, class 10 speed grade.

		7	<b>7</b>		11	₩ <u></u>			<b>**</b>	$\infty$	WAF
S-200/220	•	•	•	•	0	*	•	0	0	•	0
S-45u	•	•	•	*	•	*	•	*	*	0	*
S-450u	•	•	•	*	•	*	•	*	*	•	0

★ Industry Leading; ■ default implemented; ○ not available







FMS 2015 AWARD: MOST INNOVATIVE FLASH MEMORY TECHNOLOGY

	SD MEMORY	SD MEMORY	SD MEMORY		
	CARD	CARD	CARD		
	(SD / SDHC)	(SD / SDHC)	(SD / SDHC)		
Series Name	S-200 / 220	S-450	S-45		
Interface Data Transfer Mode	SD 2.0, Class 6 / 10	SD 3.o, Cla	ss 10, UHS-I		
Connector		SD			
Outline Dimensions		32 X 24 X 2.1 mm			
Flash Type	S	LC	MLC durabit		
Density Range	512 MB - 2 GB (SD) 4 GB - 8 GB (SDHC)	512 MB - 2 GB (SD) 4 GB - 32 GB (SDHC)	4 GB - 32 GB (SDHC) 64 GB - 128 GB (SDXC)		
Data Retention		10 years @ life begin 1 year @ life end			
Endurance	T .	P/E Cycles ell Level)	3,000 P/E Cycles (Flash Cell Level)		
Operating Temperature		Extended: -25°C to +85°C Industrial: -40°C to +85°C			
Storage Temperature		-40°C to +100°C			
Performance					
Burst Rate (MB/s) Sequential Read (MB/s)		up to 104 up to 90	up to 104 up to 40		
Sequential Write (MB/s)		up to 75	up to 40		
Random 4KB Read (IOPS)	•	up to 1200	up to 750		
Random 4KB Write (IOPS)		up to 30	up to 650		
MTBF		≥ 3,000,000 hours			
Shock	1,000 G	1,50	00 G		
Vibration	15 G	50	o G		
Humidity		85 % RH 85°C, 1,000 hrs			
Voltage		2.7 -3.6 V Normal			
Power Consumption	Read typ 28 mA Write typ 55 mA	**			
	Proven Power Fail Safety	Proven Pow	er Fail Safety		
Fastures 0 Table	Sophisticated Wear Leveling & Bad Block management		g & Bad Block management		
Features & Tools	Diagnostic features & Life Time	Autonomous Data	Care Management		
	Monitoring through SD / SPI command set	SBLTM Tool & SDK for deta	ailed Life Time Monitoring		

SFSDxxxxLvBNxss-t-dd-rrr-ccc



Part Number

SFSDxxxxLxBMxss-t-dd-rrr-ccc



#### USB FLASH DRIVES / MODULES

The Universal Serial Bus (USB) interface is very well established and has almost entirely replaced any other forms of serial or parallel interfaces for computer peripherals and memory storage devices. Advantages of USB are its flexibility, fast sequential data transfer rate, and the ability to obtain power through the connector. Most computer and embedded systems support these devices either via the standard USB connector or internal, on-board terminal headers. Swissbit offers both options in different form factors and in commercial and industrial operating temperature ranges. State of the art NAND flash handling algorithms, stringent component selection, product change control, and a 100% in-process final system test at full temperature range (-40°C to +85°C) qualify Swissbit's USB Flash Drive (UFDs) for embedded and industrial markets.

Swissbit's U-110 and U-4x Series (USB Flash Module) offers a no compromise flash based storage solution for:

- · embedded PCs that need a rugged reliable storage solution,
- · servers with backup or recovery functionality, and
- general industrial computers needing easy-to-use boot media.

All Swissbit USB solutions combine security features and Life Time Monitoring tools for product life control.

	*	7			<b>₩</b>	<u> </u>	$\infty$
U-45	•	0	•	•	•	•	•
U-400	•	0	•	•	•	•	•
U-110	•	0	•	•	•	•	•
unitedCONTRAST II	•	•	•	•	•	•	•

default implemented;
 on request;
 not available



eUSB FLASH



eUSB FLASH



eUSB FLASH



USB FLASH DRIVE

	MODULE	MODULE	MODULE					
	WIGDOLL	IVIODOLL	WIGDOLL					
C. t. N.		W - =	H	' ICONTRACT II				
Series Name	U-400	U-45	U-110	unitedCONTRAST II				
Interface			3 2.0					
Data Transfer Mode		High / Fu	ıll Speed					
Connector		Standard: 2.54 mm - 10 Pir Low Profile: 2.00 mm - 10 Pir		USB A-Plug				
Outline Dimensions		ard: 36.8 mm x 26.65 mm x 9 rofile: 36.8 mm x 26.65 mm x 9		68.0 mm x 18.0 mm x 8.0 mm				
Flash Type	SLC	MLC durabit (pSLC mode option)	SLC	SLC				
Density Range	1 GB - 16 GB (32 GB opt.)	4 GB - 32 GB	1 GB - 16 GB	512 MB - 16 GB				
Data Retention			) life begin ) life end					
Endurance	100,000 P/E Cycles (Flash Cell Level)	3,000 P/E Cycles (Flash Cell Level)		P/E Cycles ell Level)				
Operating Temperature		Commercial: o°C to +70°C Industrial: -40°C to +85°C						
Storage Temperature		-50°C t	0 +100°C					
Performance								
Burst Rate (MB/s)		up to 60	up to 60	up to 60				
Sequential Read (MB/s)		up to 32	up to 32	up to 32				
Sequential Write (MB/s) Random 4KB Read (IOPS)		up to 23 up to 650	up to 23 up to 1,600	up to 23 up to 1,600				
Random 4KB Write (IOPS		up to 650	up to 30	up to 30				
MTBF		≥ 3,000,0	ooo hours					
Shock		50	50 G					
Vibration		15	15 G					
Humidity		85 % RH 8						
			5 V ± 10 %					
Voltage	3.3 V ± 5 %	/ 5 V ± 10 %	(3.3 V ± 5 % optional)	5 V ± 10 %				
Power Consumption	Full Speed <sup>.</sup> High Speed	• •	Full Speed High Speed	-,				
Features & Tools		Proven Power Fail Safety indows / Linux — Spare block read o Bootable USB Drive Supports latest OS as Fixed Drive lector pitch & key variations ava Shock & vibration resistant	2	Proven Power Fail Safety Windows / Linux – Spare block read out Hot Pluggable / Plug & Play Optimized Wear Leveling Security features Password manager available				
Part Number	SFUIxxxxJvABx: 2.00	mm: ss-t-dd-rrr-ccc mm: ss-t-dd-rrr-ccc	2.54 mm: SFUIxxxxIvBPxss-t-dd-rrr-ccc 2.00 mm: SFUIxxxxIvBPxss-t-dd-rrr-ccc	SFU2xxxxEvBPxss-t-dd-rrr-ccc				



#### SECURITY SOLUTIONS







Security is becoming mandatory in diverse markets. Data breaches and compromised IT environments are becoming a reality. Customers and solution providers are rightly concerned about risks, creating a necessity to improve security in a reliable and flexible fashion.

That GSM calls can easily be tapped has been widely publicized in the telecommunications market. Reports about the mass interception of Internet data on a global scale compromise trust in the privacy of communications. Sophisticated attacks on industrial facilities raise questions about liability and reliability. A new class of threats and risks needs consideration. Consumers, governments, enterprises, and industry are affected by security breaches directly or indirectly, visible or invisible.

Swissbit supports its customers in industrial, medical, government, telecommunications, and the banking sector in delivering secure systems.

Each and every system requires storage to operate. While globally recognized as a leader in highly reliable flash memory solutions, Swissbit also designs, develops, and manufactures security products that provide additional security functions and features. Swissbit demonstrates a continuous, uninterrupted migration path towards secure systems while maintaining the reliability and flexibility of existing memory form factors.

Swissbit offers product related services:

- · Security firmware and drivers
- Logo printing
- Optical and electronic personalization
- Design-in of consigned smart card chips

As well as extended services:

- Security consulting
- Security training
- Customer support
- Design-in support
- · Connection with eco-system partner network for turn key solutions and quick time to market

#### SECURITY PRODUCTS

The security product series in the microSD and SD form factor addresses the growing demand for mobile, portable and industrial security. The products offer tangible hardware security in the same manner as the plug and play approach.

For various markets, Swissbit offers a broad set of security use cases. The flash memory can be used by any host to store data on the cards at high speed.

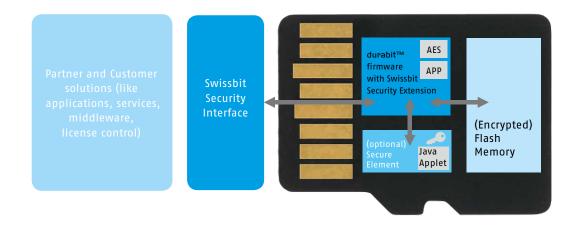
Additional security functions of the card can be activated to protect any data.

Valuable data such as sensitive files, emails, photos, OS images, FW updates, log files and audit trails can be protected by encryption, access protection, or made resistant to tampering by digital signature. Voice and video calls as well as data streams for M2M communication can

be protected by the card in high speed. The best fitting product can be chosen depending on the use case.

Our security product series provides a smart card chip or a security extension to the Swissbit durabit™ firmware or a combination of both. The block diagram below illustrates the architecture of the Swissbit Security Interface, the flash controller, and the Encrypted flash chips.

The Swissbit Security Interface empowers solution providers to build applications on various platforms. An SDK is available to develop applications on Windows™ and Linux™ PC platforms and on mobile phones and tablets like Android™ and BlackBerry™.



					\$	<b>L</b>	C	<b>P</b>		
SE	•	•	•	•	•	0	0	0	0	0
VE	•	•	•	•	•	•	•	0	0	0
FE	•	•	•	•	•	•	•	0	0	0
PE	•	•	•	•	•	•	•	•	•	•
DP	0	0	0	0	0	0	0	•	•	•

<sup>★</sup> Industry Leading; default implemented; on request; on available



# **AVAILABLE SMART CARDS CHIPS**

	SE/VE/PE	FE
	Infineon SLE 78 smart card chip CC EAL 5+ HW and OS	Infineon SLE 78 smart card chip FIPS 140-2 level 3
	Java card 3.0.4 Global Platform 2.2.1 Smart card OS jTop ID	Java card V2.2.x (ext. of V3.0) Global Platform 2.2.1 Gemalto ID Core 30
Security	RSA up to 2048 bit optional ECC up to 512 / 521 bit AES up to 256 bit SHA2 up to 512 bit RNG AIS31, FIPS-140	RSA up to 2048 bit ECC up to 512 / 521 bit AES up to 256 bit SHA2 up to 512 bit
	Compatible Middleware: <ul><li>AET SafeSign</li><li>Charismathics</li><li>Cryptovision</li></ul>	Compatible Middleware: • Gemalto
	80 k EEPROM secure storage	160 k EEPROM secure storage
Drivers / API	Windows, Mac, Linux, BlackBerry, Android SDK available	Windows, Mac, Linux, BlackBerry, Android SDK available

		PS-100u	PS-45	<b>PS-45</b> u	PS-450	PS-450u
Compliance				SD 3.0 SD, ASSD V1.1		
Data transfer / Compatible to		SPI mode supported Speed class 10	S-45	S-45u	S-450	S-450u
Temperat Compatib		-25°C to 85°C	S-45	S-45u	S-450	S-450u
Flash Typ	e		MLC		S	LC
5	SE / VE / FE / PE	8 GB - 16 GB	8 GB - 16 GB	8 GB - 16 GB	4 GB - 32 GB	512 MB - 2 GB
Density	DP	8 GB - 32 GB	4 GB - 64 GB	4 GB - 32 GB	4 GB - 32 GB	512 MB - 8 GB

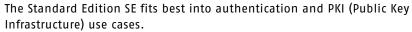


EDN has nominated the PS-100u as one of the 100 Hot Products of 2015.



#### SECURITY EDITIONS





The card is supported by leading middleware vendors in mobile, desktop, and tablet use cases to ensure a seamless design-in into existing security infrastructures.



The Voice Edition PS-100u VE provides Elliptic Curve Cryptography. The enormous advantage of computation and security combined with small certificate sizes makes a VE card ideal for online key and certificate exchange.



Solution providers choose the VE card to build secure mobile voice solutions. Typically the users (caller and person called) only need to enter their PIN into their mobile device and the security chip performs end-to-end encryption on their behalf. All encryption keys for authentication and key agreements remain highly protected in the card at all times. Only AES key stream segments suitable for voice stream encryption are passed to the mobile host application. The VE card extends the features of the SE card.



The DP and PE cards provide flash memory encryption and access protection, secure logging, and flexible CD-ROM storage.

The PE cards offer asymmetric and symmetric cryptography like the VE cards by the embedded smart card chip, whereas the DP cards offer symmetric encryption without smart card chip by the durabit<sup>TM</sup> FW.



FE cards provide a secure element according FIPS 140-2 certification. US governmental organizations and enterprises that need to follow the FIPS 140-2 security standard benefit from smart integration into a storage form factor.

SECURITY PRODUCT MATRIX		SE Standard Edition	VE Voice Edition	FE FIPS Edition	PE Premium Edition	DP Data Protection
Mobile / PC	PS-100u microSD	8 GB - 16 GB	8 GB - 16 GB	8 GB - 16 GB		8 GB - 32 GB
Medical	PS-45 SD	8 GB - 16 GB	8 GB - 16 GB	8 GB - 16 GB	8 GB - 16 GB	8 GB - 64 GB
Automotive	PS-45u microSD	8 GB - 16 GB	8 GB - 16 GB	8 GB - 16 GB	8 GB - 16 GB	8 GB - 32 GB
Industrial	PS-450 SD	4 GB - 32 GB	4 GB - 32 GB	4 GB - 32 GB	4 GB - 32 GB	4 GB - 32 GB
	PS-450u microSD	0.5 GB - 2 GB	0.5 GB - 2 GB	0.5 GB - 2 GB	0.5 GB - 2 GB	0.5 GB - 2 GB



Swissbit commits to offering the highest quality, JEDEC standard and customized DRAM modules for industrial applications. As a DRAM module manufacturer, we use strategic multiple sources of DRAM suppliers to offer our customers a reliable, long-term supply of leading edge and legacy memory module products. Special focus is put into working with suppliers that offer extended availability of DRAM die revisions, avoiding frequent requalification efforts with our customers.

Swissbit's quality focus starts with sourcing the highest quality DRAMs and utilizing fully compliant JEDEC module raw cards either as in-house PCB design or from top quality design partners. For all modules, the passives and other active components selected are of the highest available quality. Using surface mount technology (SMT) processes in production on fully certified facilities in Germany allows Swissbit to sustain a quality focus during the entire assembly process. Traceability is guaranteed through the complete manufacturing and testing flow. We ensure the highest quality level for our customers with world class application testing. Swissbit uses in-house developed application software to test 100 % of all modules under real-world conditions with diverse pattern and stress methods and to cover the complete memory array including ECC components by constantly adapting to the latest memory controller features. For industrial temperature grade modules the application tests are performed at -40°C and +85°C TAMBIENT.

With a stringent internal product qualification which is driven by our dedication to always be an improving company, Swissbit constantly works on providing its customers the best DRAM modules available on the market at a competitive price. Swissbit is committed and able to design, manufacture, and test customer-specific module solutions. We offer PCB design and layout services, development of individual test solutions, thermal simulations, DRAM component sourcing, controlled manufacturing, and special coating options.

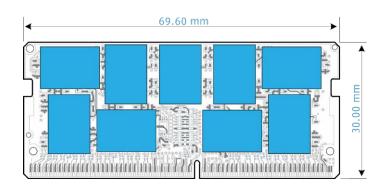
By using Swissbit DRAM modules, you can keep the total system cost to a minimum.



#### DRAM SPECIFIC OPTIONS



	<b>*</b>	<b>(7)</b>		333	<b>Z</b> 0	
DDR1 DIMM/RDIMM	•	0	0	0	0	
DDR1 SODIMM/SO-RDIMM	•	0	0	0	0	
DDR2 DIMM/RDIMM	•	0	0	0	0	
DDR2 SODIMM	•	0	0	•	0	
DDR3 DIMM	•	0	0	0	•	
DDR3 RDIMM	•	0	•	•	•	
DDR3 MINIDIMM	•	0	•	•	•	
DDR3 SODIMM/SO-UDIMM	•	0	•	•	•	•
DDR3 XR-DIMM	•	•	•	0	•	
	default imp	lemented: 0 c	on request: O	not available		



DDR4, FASTER AT LOW POWER

With its architectural features and the subsequent extension to 1.35 V, DDR3 technology had the widest range of data rates. But the end of DDR3 technology's evolution has finally come. Further improvements were necessary to open a path for even higher data rates. The new JEDEC standard, DDR4 addresses, these requirements. Its spec targets a doubling of the data rate from today's DDR3-1600 to a blazing DDR4-3200. The introduction of DDR4 already starts at 2133 Mb/s and offers a 30% higher bandwidth compared to main stream DDR3L speed.

At the same time, the operating voltage could be reduced from 1.35 V to 1.20 V. Together with several new power saving features like an improved termination scheme, data bus inversion, and grouping of banks, the total power

consumption and heat dissipation has been significantly reduced vis-à-vis DDR3L.

The DDR4 standard also adds reliability features like CRC and command / address bus parity.

DDR4 has been fully standardized at JEDEC and the most recent memory controllers support it.

Swissbit will offer a complete portfolio of DDR4 modules as JEDEC releases them, focusing on the form factors that are most important to the industrial market, beginning with ECC SODIMMs.









Designers of rugged platforms face a difficult decision when planning their memory layout: either they use DRAM components directly soldered to the system board, the most rugged but also expensive and inflexible solution, or they try to ruggedize standard SODIMMs by using straps or glue to fasten them in their sockets.

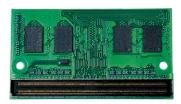
In cooperation with the SFF-SIG consortium (Small Form Factor-Special Interest Group), Swissbit has developed a rugged module called XR-DIMM  $^{\!\mathsf{TM}}\!$  , the abbreviation XR standing for eXtreme Rugged.

Using special mezzanine connectors and mounting holes to attach the module to the system board creates a truly rugged system with the easy integration and flexibility of DIMM solutions and the shock and vibration immunity of memory down implementations.

The XR-DIMM closely follows the DDR3 72 bit SODIMM standard and makes design-in as easy as using a JEDEC module, unburdening the system designer from memory channel layout.

With multiple module densities, the system integrator can create different memory populations with one system platform, avoiding multiple system board SKUs and taking advantage of perfectly tested modules with a just-in-time purchase option.





	Memory down	SODIMM with fixture	XR-DIMM
DESIGN-IN/LAYOUT	Difficult	Easy	Easy
FLEXIBILITY OF MEMORY POPULATION	Difficult	Easy	Easy
TESTABILITY AFTER SOLDERING	Medium	Easy	Easy
UPGRADE/REPAIR	Difficult	Easy	Easy
REQUIRED BOARD SPACE	Small to Medium	Medium to Small	Medium to Small
STACKABLE SOLUTION	No	Yes	Yes
PROTECTION AGAINST SHOCK	Good	Medium (with glue / strap)	Good
PROTECTION AGAINST VIBRATION	Good	Bad	Good
MEMORY COST	Low to Medium	Low	Medium

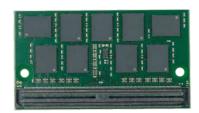
# UNBUFFERED DIMM PRODUCTS



# LONG UDIMM/WITH AND WITHOUT ECC

	Data Rate / CL	Density	0rg	Height	Voltage	Pins	Partnumber	Package
DDR4-UDIMM	2133 / CL15	4 GB - 16 GB	x64	31.25 mm	1.20 V	260	SHUxxx64xxxxxxx-ssR	BGA
DDR3L-UDIMM	1600 / CL11	2 GB - 8 GB	x64	1.18" (29.97 mm)	1.35 / 1.50 V	240	SLUxxx64xxxxxxx-ssR	BGA
DDR3L-UDIMM ECC	1600 / CL11	2 GB - 8 GB	X72	1.18" (29.97 mm)	1.35 / 1.50 V	240	SLUxxx72xxxxxxx-ssR	BGA
DDR2-UDIMM	800 / CL6	512 MB - 2 GB	x64	1.18" (29.97 mm)	1.80 V	240	SEUxxx64xxxxxxx-ssR	BGA
DDR2-UDIMM ECC	800 / CL6	1 GB - 2 GB	X72	1.18" (29.97 mm)	1.80 V	240	SEUxxx72xxxxxxx-ssR	BGA
DDR1-UDIMM	400 / CL3	512 MB - 1 GB	x64	1.25" (31.75 mm)	2.50 V	184	SDUxxx64xxxxxxx-ssR	TSOP
DDR1-UDIMM ECC	400 / CL3	512 MB - 1 GB	X72	1.25" (31.75 mm)	2.50 V	184	SDUxxx72xxxxxxx-ssR	TSOP





# SODIMM/WITH AND WITHOUT ECC/RUGGED XR-DIMM

	Data Rate / CL	Density	0rg	Height	Voltage	Pins	Partnumber	Package
DDR4-SODIMM	2133 / CL15	4 GB - 16 GB	x64	30 mm	1.20 V	260	SHNxxx64xxxxxxx-ssRT	BGA
DDR4-SODIMM ECC	2133 / CL15	4 GB - 16 GB	X72	30 mm	1.20 V	260	SHNxxx72xxxxxxx-ssRT	BGA
DDR3L-SODIMM	1600 / CL11	1 GB - 8 GB	x64	1.18" (29.97 mm)	1.35 / 1.50 V	204	SLNxxx64xxxxxxx-ssRT	BGA
DDR3L-SO-UDIMM	1600 / CL11	2 GB - 8 GB	X72	1.18" (29.97 mm)	1.35 / 1.50 V	204	SLNxxx72xxxxxxx-ssRT	BGA
DDR3-SODIMM	1600 / CL11	1 GB - 8 GB	x64	1.18" (29.97 mm)	1.50 V	204	SGNxxx64xxxxxxx-ssRT	BGA
DDR3-SO-UDIMM	1600 / CL11	1 GB - 8 GB	X72	1.18" (29.97 mm)	1.50 V	204	SGNxxx72xxxxxxx-ssRT	BGA
DDR3-XR-DIMM™	1600 / CL11	1 GB - 8 GB	X72	38 mm x 67.5 mm	1.35 / 1.50 V	240	SLVxxx72xxxxxxx-ssRT	BGA
DDR2-SODIMM	800 / CL6	512 MB - 4 GB	x64	1.18" (29.97 mm)	1.80 V	200	SENxxx64xxxxxxx-ssR	BGA
DDR1-SODIMM	400 / CL3	256 MB - 1 GB	x64	1.25" (31.75 mm)	2.50 V	200	SDNxxx64xxxxxxx-ssR	BGA



# MINI-UDIMM/100PIN-DIMM

	Data Rate / CL	Density	0rg	Height	Voltage	Pins	Partnumber	Package
DDR3-MiniUDIMM	1600 / CL11	2 GB - 8 GB	X72	1.18" / 0.74"	1.50 V	244	SGLxxx72xxxxxxx-ssRT	BGA
DDR1-100PIN_DIMM	333 / CL2.5	128 MB - 512 MB	X72	1.00" (25.40 mm)	2.50 V	100	SDUxxx32xxxxxxx-ssR	TSOP



#### MODULE OPTIONS



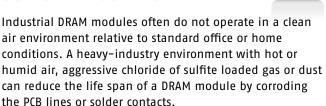
#### **HEAT SPREADER**

The critical condition for DRAMs is a high die temperature, because it leads to loss of cell information. With die sizes continually shrinking, power dissipation is concentrated on only a few square millimeters. Adding a heat spreader to a module allows the hot spots to more easily dissipate the heat over a bigger surface. This heat spreader levels out the module's heat dissipation, thus reducing the hot-spot temperature and improving the module's reliability.

Swissbit offers heat-spreader solutions for some of its industrial temperature grade SODIMMs and MiniDIMMs.



#### **CONFORMAL COATING**

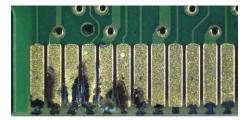


Swissbit offers a full module surface coating with a thin film of polyurethane, which effectively protects against most hazardous environmental conditions. The module's endurance is greatly improved with this protection, thus reducing maintenance periods and avoiding sudden breakdown of a system. This option is currently available for SODIMMs as well as for several flash products.

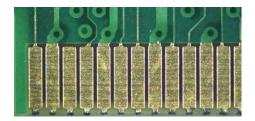


#### **CORROSION RESISTANCE**

For demanding applications Swissbit uses a thick, 30 microinch layer of gold on the DIMM contacts and special sulfur corrosion resistant passives to offer the highest reliability and longest lifetime.



UNPROTECTED PCB AFTER HIGHLY **ACCELERATED CORROSION TEST** 



SWISSBIT PROTECTED PCB AFTER HIGHLY ACCELERATED **CORROSION TEST** 



#### **TEMPERATURE SENSOR**

For all DDR3 SODIMMs, MiniDIMMs, and registered DIMMs, Swissbit offers an integrated temperature sensor by default within the SPD device. It allows permanent monitoring of the module temperature over the system management bus. By utilizing this feature, system management can actually control the module's self-heating in a more accurate manner than by using calculation methods for memory throttling. This results in greater useable bandwidth and avoids overheating of the module.



# INDUSTRIAL TEMPERATURE RANGE

Besides modules for commercial temperature range o°C to +70°C, Swissbit also offers products for an extended temperature range of o°C to +85°C TAMBIENT as well as the full industrial temperature range -40°C to +85°C TAMBIENT. With intensive application testing of each individual module at low and high temperature, Swissbit ensures the highest quality and reliability of their products.



# LONG RDIMM / STANDARD HEIGHT / WITH ECC AND C/A PARITY

	Data Rate / CL	Density	0rg	Height	Voltage	Pins	Partnumber	Package
DDR3L-RDIMM ECC+PARITY	1600 / CL11	4 GB - 8 GB	X72	1.18" (29.97 mm)	1.35 V	240	SLPxxx72xxxxxx-ssR	BGA
DDR3-RDIMM ECC+PARITY	1333 / CL9	1 GB - 8 GB	X72	1.18" (29.97 mm)	1.50 V	240	SGPxxx72xxxxxx-ssR	BGA
DDR2-RDIMM ECC+PARITY	800 / CL6	1 GB - 4 GB	X72	1.18" (29.97 mm)	1.80 V	240	SEPxxx72xxxxxxx-ssR	BGA



# LOW PROFILE LONG RDIMM, UDIMM / WITH ECC

	Data Rate / CL	Density	0rg	Height	Voltage	Pins	Partnumber	Package
DDR3-RDIMM ECC+PARITY	1333 / CL9	2 GB - 8 GB	X72	o.70" (17.78 mm)	1.50 V	240	SGPxxx72xxxxxxx-ssR	BGA
DDR3L-UDIMM ECC	1600 / CL11	2 GB - 8 GB	X72	0.74" (18.90 mm)	1.35 V	240	SLUxxx72xxxxxxx-ssR	BGA
DDR3-UDIMM ECC	1333 / CL9	2 GB - 4 GB	X72	o.70" (17.78 mm)	1.50 V	240	SGUxxx72xxxxxxx-ssR	BGA
DDR2-RDIMM ECC+PARITY	800 / CL6	1 GB - 2 GB	X72	0.72" (18.29 mm)	1.80 V	240	SEPxxx72xxxxxxx-ssR	BGA

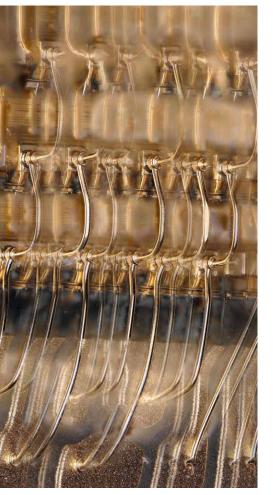




# VLP MINIRDIMM WITH ECC, REGISTERED SO-RDIMM WITH ECC

	Data Rate / CL	Density	0rg	Height	Voltage	Pins	Partnumber	Package
DDR3-MiniRDIMM	1333 / CL9	2 GB - 4 GB	X72	0.72" (18.29 mm)	1.50 V	244	SGHxxx72xxxxxxx-ssR	BGA
DDR2-MiniRDIMM	667 / CL5	1 GB	X72	0.72" (18.29 mm)	1.80 V	244	SEHxxx72xxxxxxx-ssR	BGA
DDR2-SO-RDIMM	667 / CL5	1 GB - 2 GB	X72	1.18" (29.97 mm)	1.80 V	200	SEGxxx72xxxxxxx-ssR	BGA





System-in-Package (SiP) is the processing of sensitive bare dies or chips into robust finished modules or components. With 20 years of experience, Swissbit successfully uses advanced packaging technologies to achieve the smallest form factors and to build multi-chip-packages. With this electronic integration approach, our products provide more functionality or highest memory densities inside one package, various functional blocks (RF, digital, sensors, security, and memory) as well as passive components are combined.

Beginning with the wafer and bare die handling, Swissbit utilizes a flexible chip-on-board (COB) assembly and packaging line. Processes like SMT assembly, die bonding, Au and Al wire bonding, dam&fill, transfer molding, precise separation with laser technology and sawing, housing, labeling, laser marking, etc. are very well established.

Die stacking, especially for flash and DRAM, is one of our expertises besides the integration of additional hardware features and an experienced team of testing and quality engineers. Our own Memory-In-Package line qualifies (but does not limit) Swissbit as the development and production partner for any dedicated or customized memory-related product with challenging integration or reliability requirements. If you cannot satisfy the special demands regarding space and performance using traditional components and processes, Swissbit offers feasibility studies, manages or supports your development project, and produces prototypes and small and mid-size volumes (up to 50,000 pieces / month). We will aid you beginning at your project's conception: from the design phase, prototyping, determining the circuit layout, and material selection to preparing the appropriate packaging for transport.

Swissbit produces and develops according to ISO 9001:2008, TS 16949, and ISO 14001 approved processes and is an experienced partner in global industrial and automotive accounts.

Swissbit's technology portfolio combined with its strong engineering know-how and experience enables new, innovative MCP (Multi Chip Packages)/SiP/COB configurations like stacked dies, side-by-side, sensors integration, etc. System-in-Package solutions could be smaller, cheaper, and having tighter security.

System-in-Package benefits:

- Reduced process complexity
- Lower TCO (total cost of ownership)
- Reduced system board space due to smaller sized solutions than individually packaged ICs
- · Layer count reduction in System PCB
- · Reduced board mounted height
- Mixed analog / digital design
- · Reduced system board test complexity

SWISSBIT SIP AND COB COMPETENCY

CONCEPTION

DEVELOPMENT

VERIFICATION & QUALIFICATION

PRODUCTION

LOGISTICS

- Product definition
- Feasibility studies
- Verification plan
- Qualification plan
- Design for test
- Design for production
- Design to cost

- Package
- development
- Process
- development
- Substrate layoutTest engineering

and development

Failure analysis consulting

- Product verification
- Debugging
- Optimization
- Reliability testing
- · Life time
- Compliance to CE / FCC / VCCI, UL, RoHS, and REACH
- Fast prototyping
- Ramp up
- Yield management
- · Series production of:
  - •SMT
  - •SiP
  - •COB
  - •M(P
  - •BGA

- Stock management
- Supply chain management
- One-stop sourcing

SWISSBIT IS OFFERING THE FOLLOWING PRODUCTION TECHNOLOGIES



SMD



SEPARATION/ SINGULATION



DIE ATTACH/CHIP BONDING/ DIE STACKING



WIRE BONDING



ENCAPSULATION



ADHESIVE APPLY

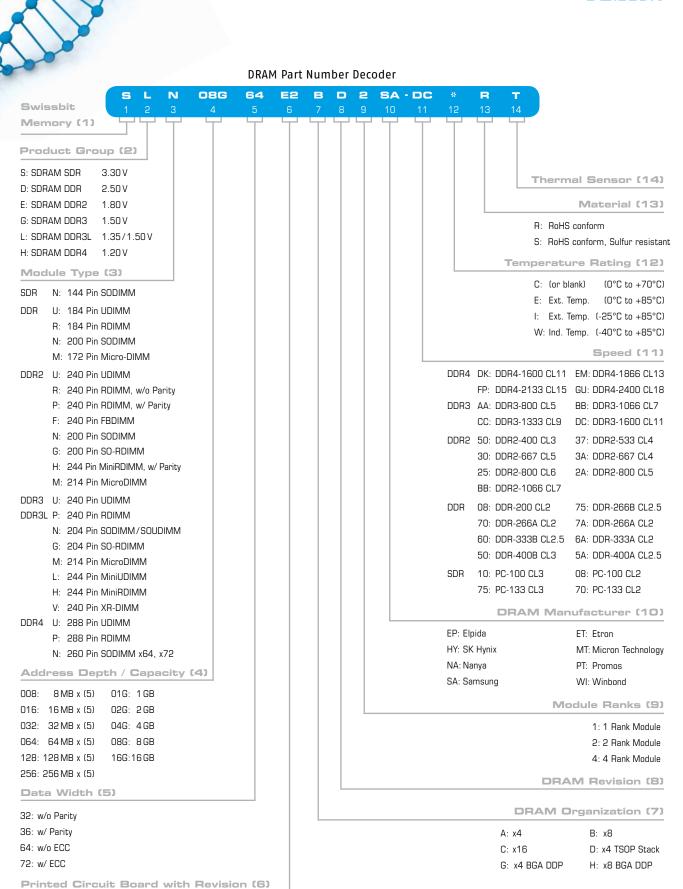


MARKING



CONFORMAL COATING









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